



Product data sheet

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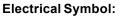




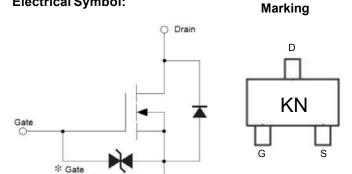


Low On-resistance

- Fast Switching Speed
- Low Voltage Drive Makes This Device Ideal for Portable Equipment
- Easily Designed Drive Circuits
- Easy to Parallel
- RoHS Compliant & Green EMC
- Matte Tin(Sn) Lead Finish
- Weight: approx. 0.002g



Protection Diode



Absolute Maximum Ratings T_A = 25°C unless otherwise noted

O Source

Symbol	Parameter	Value	Units	
V _{DS}	Drain-Source Voltage	30	V	
V _{GS}	Continuous Gate-Source Voltage	±20V	V	
ID	Continuous Drain Current	100	mA	
PD	Power Dissipation	150	mW	
R _{0JA}	Thermal Resistance from Junction to Ambient	833	°C /W	
T _{stg}	Storage Temperature Range	-55 to +150	°C	
TJ	Operating Junction Temperature	+150	°C	





Electrical Characteristics (T_A = 25°C unless otherwise noted)

Off Characteristics

Symbol	Deveneter	Test Condition	Limits			11
Symbol	Parameter		Min	Тур	Мах	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V, I _D =10uA	30			Volts
I _{GSS}	Gate-Body Leakage	V_{DS} =0V, V_{GS} = \pm 20V			±1	uA
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} =30V, V_{GS} =0V			1	μA

On Characteristics

Gumbal	Parameter	Toot Condition	Limits			11:0:1
Symbol		Test Condition	Min	Тур	Мах	Unit
$V_{th(GS)}$	Gate-Threshold Voltage	V_{DS} = 3V, I_D =100uA	0.8		1.5	Volts
R _{DS(on)}	Drain-Source On-Resistance	V _{GS} =4V, I _D =10mA			8	Ω
		V _{GS} =2.5V, I _D =1mA			13	Ω
g fs	Forward Trans Conductance	V_{DS} =3V, I_{D} =10mA	20			ms
V _{SD}	Drain-Source Diode Forward Voltage	I _S =115mA, V _{GS} =0V			1.2	V

Dynamic Characteristics

Symbol	Deveneeter	Test Condition	Limits			11
Symbol	Parameter		Min	Тур	Мах	Unit
Ciss	Input Capacitance	V _{DS} = 5V		13		pF
Coss	Output Capacitance	$V_{GS} = 0V$		9		pF
Crss	Reverse Transfer Capacitance	f = 1.0MHz		4		pF

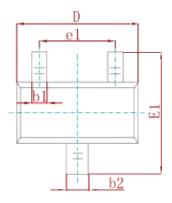
Switching Characteristics

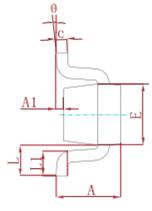
Gumbal	Devementer	Demonster Test Ocealities		Limits		11
Symbol	Parameter Test	Test Condition	Min	Тур	Мах	Unit
t _{D(on)}	Turn-on Time	V_{DD} =5V, R _L =500 Ω ,		15		nS
t _{D(off)}	Turn-off Time	I_D =10mA, V_{Gs} =5V, R _G = 10Ω		80		nS

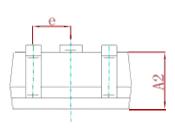




PACKAGE MECHANICAL DATA

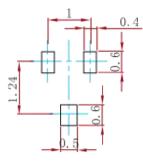






0h.e.l	Dimensions I	Dimensions In Millimeters		s In Inches
Symbol	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
A1	0.000	0.100	0.000	0.004
A2	0.700	0.800	0.028	0.031
b1	0.150	0.250	0.006	0.010
b2	0.250	0.350	0.010	0.014
С	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E	0.700	0.900	0.028	0.035
E1	1.450	1.750	0.057	0.069
e	0.500	TYP.	0.020 TYP.	
e1	0.900	1.100	0.035	0.043
L	0.400 REF.		0.016	REF.
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

Suggested Pad Layout



Note: 1.Controlling dimension:in millimeters. 2.General tolerance:±0.05mm. 3.The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
2SK3019-MS	SOT-523	3000



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